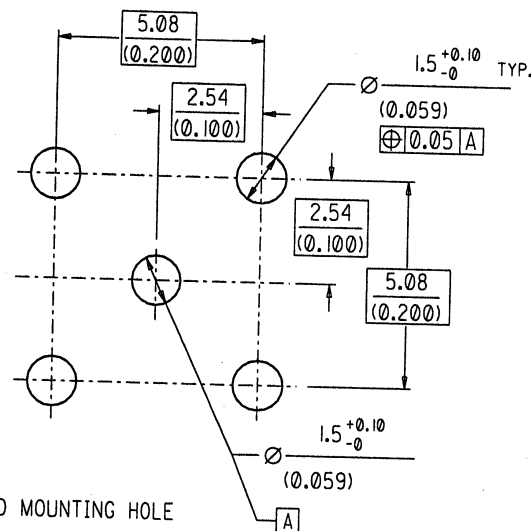
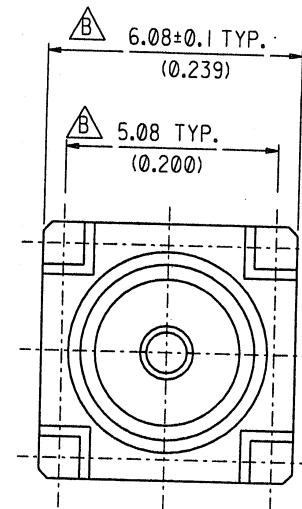
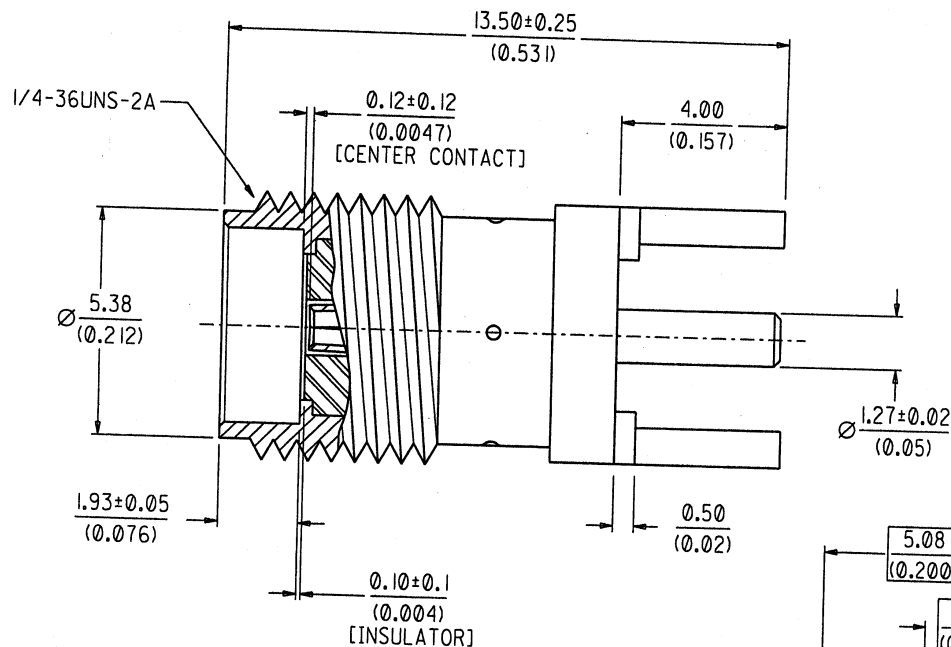




CONSTRUCTION:

BODY-----BRASS
 INSULATOR -----TEFLON
 CENTER CONTACT -----BERYLLIUM COPPER

FINISH :

BODY -----GOLD PLATING (10 U" MIN.)
 CENTER CONTACT----- GOLD PLATING (10 U" MIN.)

MECHANICAL & ELECTRIC CHARACTERISTICS:
 PER PRODUCT SPECIFICATION PS-73436-009

PACKAGING : TRAY

RECOMMENDED MOUNTING HOLE

CHANGE DIMENSION EC NO. RF-0122 DRWN: LYNN LIN CHK: JOHNSON CHANG APPR: MISEN HUANG	NEW RELEASE EC NO. RF-0110 DRWN: LYNN LIN CHK: MISEN HUANG APPR: MISEN HUANG	QUALITY SYMBOLS MAJOR = CRITICAL =	GENERAL TOLERANCES: (UNLESS SPECIFIED)		SCALE 8:1	DESIGN UNITS ☒ mm ☐ INCH	THIRD ANGLE PROJECTION	DIMENSIONS: ☒ mm ☐ INCH ☐ mm ONLY	SHT	REV		
			4 PLACES ±0.1	3 PLACES ±0.1	2 PLACES ±0.25	1 PLACE ±0.25	ANGULAR: ±3°	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DRAWN BY & DATE LYNN LIN 981019		TITLE: 50 OHM SMA (J) VERTICAL PCB RECEPTACLE	
			CHECKED BY & DATE A. Chang		APPROVED BY & DATE Misen Huang		MATERIAL NO. 73391-0070		DRAWING NO. SD-73391-007		SHEET NO. 1 OF 1	
			CAD FILENAME S391007.S01		MOLEX INCORPORATED		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.		SIZE A3			